VS-GB50NA120UX

Vishay Semiconductors



"High Side Chopper" IGBT SOT-227 (Ultrafast IGBT), 50 A



SOT-227

| PRODUCT SUMMARY | | | | | | | |
|--|------------------|--|--|--|--|--|--|
| V _{CES} | 1200 V | | | | | | |
| I _C DC | 50 A at 92 °C | | | | | | |
| V _{CE(on)} typical at 50 A, 25 °C | 3.22 V | | | | | | |
| Speed | 8 kHz to 30 kHz | | | | | | |
| Package | SOT-227 | | | | | | |
| Circuit | High side switch | | | | | | |

FEATURES

- NPT Gen 5 IGBT technology
- Square RBSOA
- HEXFRED[®] clamping diode
- Positive V_{CE(on)} temperature coefficient
- · Fully isolated package
- Very low internal inductance (≤ 5 nH typical)
- Industry standard outline
- UL approved file E78996
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

BENEFITS

- · Designed for increased operating efficiency in power conversion: UPS, SMPS, welding, induction heating
- Easy to assemble and parallel
- · Direct mounting on heatsink
- · Plug-in compatible with other SOT-227 packages
- · Low EMI, requires less snubbing

| ABSOLUTE MAXIMUM RATINGS | | | | | | |
|----------------------------------|-------------------|--|------|-------|--|--|
| PARAMETER | SYMBOL | TEST CONDITIONS | MAX. | UNITS | | |
| Collector to emitter voltage | V _{CES} | | 1200 | V | | |
| Continuous collector current | 1- | T _C = 25 °C | 84 | | | |
| | I _C | T _C = 80 °C | 57 | | | |
| Pulsed collector current | I _{CM} | | 150 | А | | |
| Clamped inductive load current | I _{LM} | | 150 | A | | |
| Diode continuous forward current | ١ _F | T _C = 25 °C | 76 | | | |
| | | T _C = 80 °C | 52 | | | |
| Gate to emitter voltage | V _{GE} | | ± 20 | V | | |
| Power dissipation, IGBT | Б | T _C = 25 °C | 431 | | | |
| | P _D | T _C = 80 °C | 242 | W | | |
| | P _D | T _C = 25 °C | 278 | vv | | |
| Power dissipation, diode | | T _C = 80 °C | 156 | | | |
| RMS isolation voltage | V _{ISOL} | V _{ISOL} Any terminal to case, t = 1 min 2500 | | V | | |



COMPLIANT



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| PARAMETER | SYMBOL | TEST CONDITIONS | MIN. | TYP. | MAX. | UNITS | | |
|--|-------------------------|---|------|------|-------|-------|--|--|
| Collector to emitter breakdown voltage | V _{BR(CES)} | $V_{GE} = 0 V, I_C = 1 mA$ | 1200 | - | - | | | |
| | | V _{GE} = 15 V, I _C = 25 A | - | 2.46 | - | | | |
| | N | V _{GE} = 15 V, I _C = 50 A - | | 3.22 | 2.80 | v | | |
| Collector to emitter voltage | V _{CE(on)} | V _{GE} = 15 V, I _C = 25 A, T _J = 125 °C | - | 2.84 | 3.60 | | | |
| | | V_{GE} = 15 V, I _C = 50 A, T _J = 125 °C | - | 3.78 | 3.0 | | | |
| Gate threshold voltage | V _{GE(th)} | $V_{CE} = V_{GE}$, $I_C = 500 \ \mu A$ | 4 | 5 | 4 | 1 | | |
| Temperature coefficient of threshold voltage | $V_{GE(th)}/\Delta T_J$ | V_{CE} = V_{GE} , I_C = 1 mA (25 °C to 125 °C) | - | -10 | - | mV/°C | | |
| Collector to emitter leakage current | | V _{GE} = 0 V, V _{CE} = 1200 V | - | 6 | 50 | μA | | |
| | I _{CES} | $V_{GE} = 0 \text{ V}, V_{CE} = 1200 \text{ V}, \text{T}_{\text{J}} = 125 ^{\circ}\text{C}$ | - | 0.7 | 2.0 | mA | | |
| Diode reverse breakdown voltage | V _{BR} | I _R = 1 mA | 1200 | - | - | V | | |
| | | I _C = 25 A, V _{GE} = 0 V | - | 1.99 | 2.42 | | | |
| Diada famuard valtaga dran | V _{FM} | $I_{C} = 50 \text{ A}, V_{GE} = 0 \text{ V}$ - | | 2.53 | 3.00 | V | | |
| Diode forward voltage drop | | $I_{C} = 25 \text{ A}, V_{GE} = 0 \text{ V}, T_{J} = 125 ^{\circ}\text{C}$ | - | 1.96 | 2.30 | v | | |
| | | $I_{C} = 50 \text{ A}, V_{GE} = 0 \text{ V}, T_{J} = 125 ^{\circ}\text{C}$ | - | 2.66 | 3.08 | | | |
| | | $V_{R} = V_{R}$ rated | - | 4 | 50 | μA | | |
| Diode reverse leakage current | I _{RM} | $T_J = 125 \text{ °C}, V_R = V_R \text{ rated}$ | - | 0.6 | 3 | mA | | |
| Gate to emitter leakage current | I _{GES} | V _{GE} = ± 20 V | - | - | ± 200 | nA | | |

| PARAMETER | SYMBOL | TEST CONDIT | MIN. | TYP. | MAX. | UNITS | |
|------------------------------------|---------------------|--|---|------------|------|-------|----|
| Total gate charge (turn-on) | Qg | | | - | 400 | - | |
| Gate to emitter charge (turn-on) | Q _{ge} | $I_{\rm C} = 50$ A, $V_{\rm CC} = 600$ V, V | / _{GE} = 15 V | - | 43 | - | nC |
| Gate to collector charge (turn-on) | Q _{gc} | | - | 187 | - | | |
| Turn-on switching loss | E _{on} | $I_{\rm C} = 50$ A, $V_{\rm CC} = 600$ V, | - | - | 2.72 | - | mJ |
| Turn-off switching loss | E _{off} | $V_{GE} = 15 \text{ V}, \text{ R}_{g} = 5 \Omega,$ | | - | 1.11 | - | |
| Total switching loss | E _{tot} | L = 500 µH, T _J = 25 °C | | - | 3.83 | - | |
| Turn-on switching loss | E _{on} | | Energy losses include tail and diode recovery (see fig. 18) | - | 3.94 | - | |
| Turn-off switching loss | E _{off} | | | - | 2.31 | - | |
| Total switching loss | E _{tot} | I _C = 50 A, V _{CC} = 600 V, | | - | 6.25 | - | |
| Turn-on delay time | t _{d(on)} | $V_{GE} = 15 \text{ V}, \text{ R}_{g} = 5 \Omega,$ | | - | 191 | - | ns |
| Rise time | t _r | L = 500 µH, T _J = 125 °C | | - | 53 | - | |
| Turn-off delay time | t _{d(off)} | | | - | 223 | - | |
| Fall time | t _f | | | - | 143 | - | |
| Reverse bias safe operating area | RBSOA | $\begin{split} T_{J} &= 150 \ ^{\circ}\text{C}, \ I_{C} &= 150 \ \text{A}, \\ V_{GE} &= 15 \ \text{V to } 0 \ \text{V}, \ V_{CC} &= \\ V_{P} &= 1200 \ \text{V} \end{split}$ | | Fullsquare | | | |
| Diode reverse recovery time | t _{rr} | | | - | 129 | 161 | ns |
| Diode peak reverse current | l _{rr} | $I_F = 50 \text{ A}, \text{ d}I_F/\text{d}t = 200 \text{ A}/1000 $ | $I_F = 50 \text{ A}, \text{ d}I_F/\text{d}t = 200 \text{ A}/\mu\text{s}, \text{ V}_R = 200 \text{ V}$ | | | | А |
| Diode recovery charge | Q _{rr} | - | | | | 1046 | nC |
| Diode reverse recovery time | t _{rr} | | , | - | 208 | 257 | ns |
| Diode peak reverse current | I _{rr} | I _F = 50 A, dI _F /dt = 200 A/ V _B = 200 V, T _J = 125 °C | μs, | - | 17 | 21 | А |
| Diode recovery charge | Q _{rr} | $v_{\rm R} = 200 v, 1j = 125 C$ | - | 1768 | 2698 | nC | |

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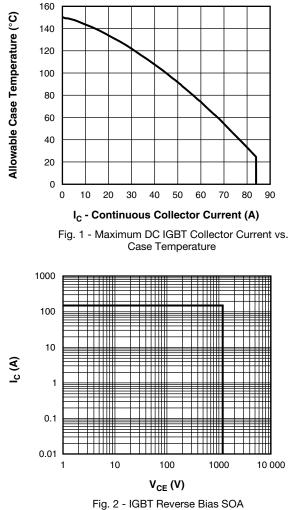
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| THERMAL AND MECHANICAL SPECIFICATIONS | | | | | | | |
|---------------------------------------|-------|-----------------------------------|-----------------------|------|------|------|-------|
| PARAMETER | | SYMBOL | | MIN. | TYP. | MAX. | UNITS |
| Junction and storage temperature | range | T _J , T _{Stg} | | -40 | - | 150 | °C |
| Junction to case | IGBT | | | - | - | 0.29 | |
| Junction to case | Diode | - R _{thJC} | | - | - | 0.45 | °C/W |
| Case to heatsink | | R _{thCS} | Flat, greased surface | - | 0.05 | - | |
| Weight | | | | - | 30 | - | g |
| Mounting torque | | | | - | - | 1.3 | Nm |
| Case style | | SOT-227 | | | | | |



T_J = 150 °C, V_{GE} = 15 V

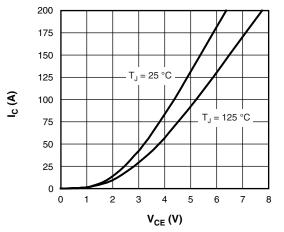


Fig. 3 - Typical IGBT Collector Current Characteristics

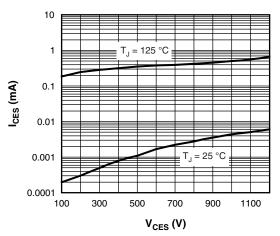
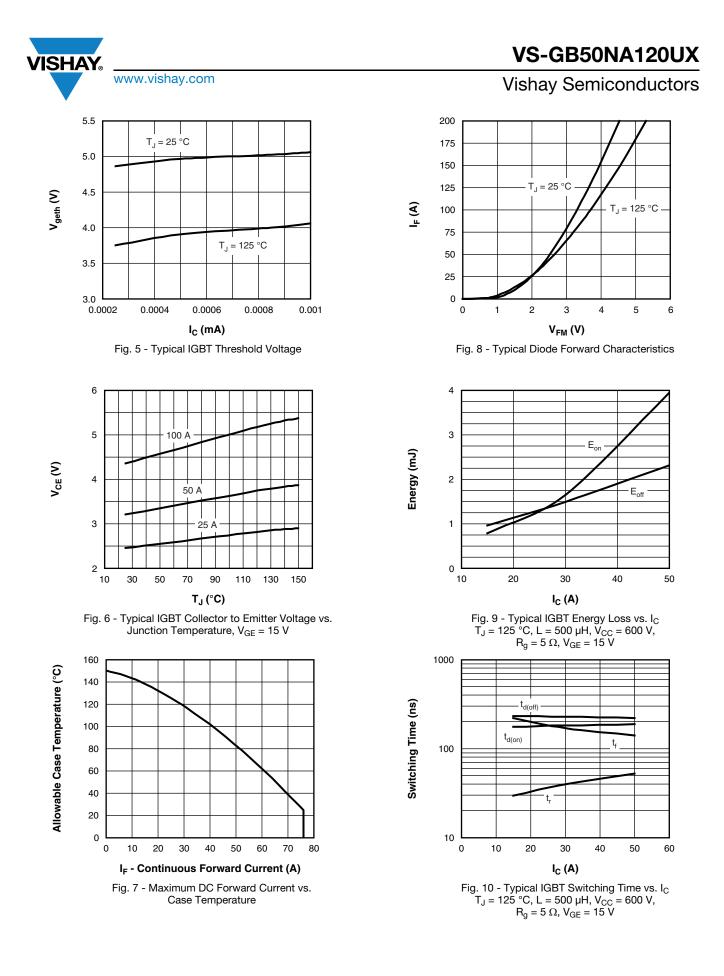


Fig. 4 - Typical IGBT Zero Gate Voltage Collector Current

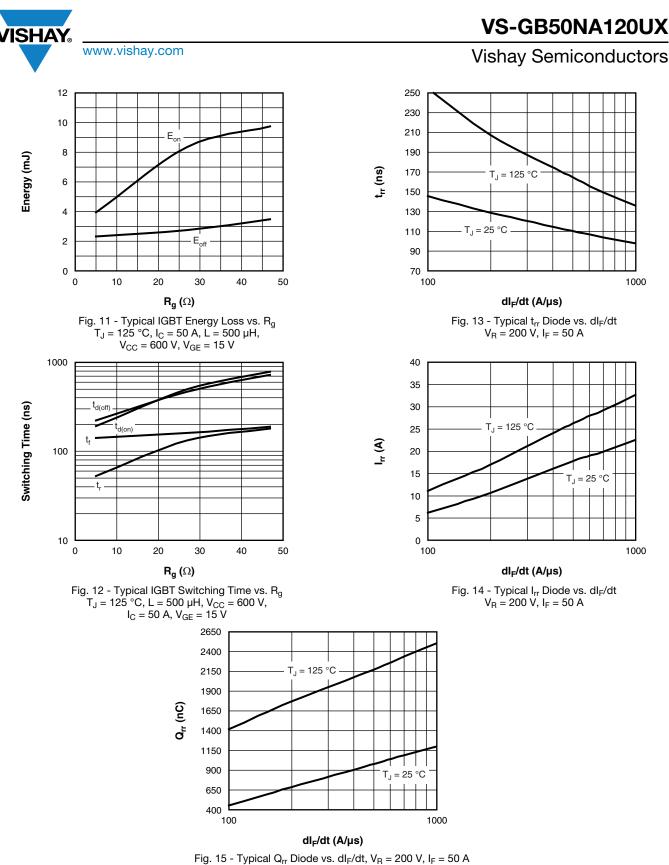


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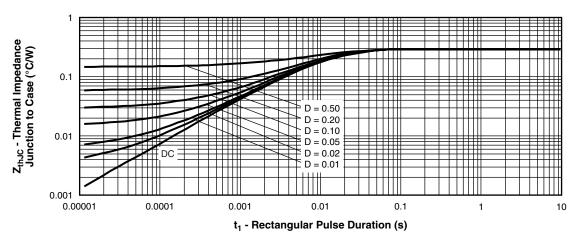
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Fig. 16 - Maximum Thermal Impedance ZthJC Characteristics (IGBT)

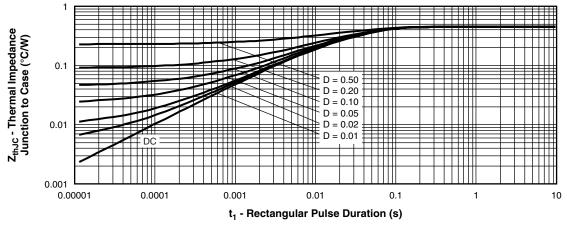
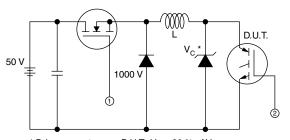


Fig. 17 - Maximum Thermal Impedance Z_{thJC} Characteristics (Diode)



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Driver same type as D.U.T.; V_C = 80 % of V_{ce(max)}
 Note: Due to the 50 V power supply, pulse width and inductor will increase to obtain Id

Fig. 18a - Clamped Inductive Load Test Circuit

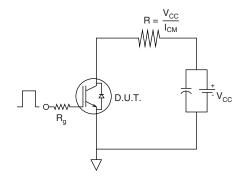


Fig. 18b - Pulsed Collector Current Test Circuit

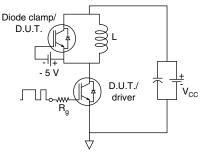


Fig. 19a - Switching Loss Test Circuit

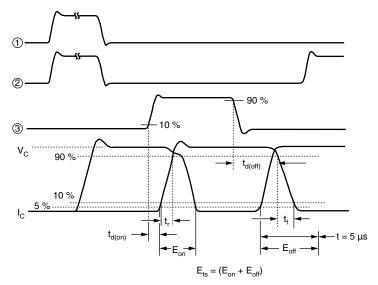


Fig. 19b - Switching Loss Waveforms Test Circuit

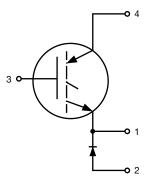
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ORDERING INFORMATION TABLE

| Device code | VS- | G | В | 50 | N | Α | 120 | U | x |
|-------------|------------|--|---|----|---|---|-----|---|---|
| | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 |
| | 1 - 2 - | Insulated Gate Bipolar Transistor (IGBT) | | | | | | | |
| | 3 - 4 - | | | | | | | | |
| | 5 - | Circ | Circuit configuration (N = High side chopper) | | | | | | |
| | 6 - | Pac | Package indicator (A = SOT-227) | | | | | | |
| | 7 - | Volt | Voltage rating (120 = 1200 V) | | | | | | |
| | 8 - | Spe | Speed/type (U = Ultrafast IGBT) | | | | | | |
| | 9 - | X = | X = F/W HEXFRED [®] diode | | | | | | |

CIRCUIT CONFIGURATION



| LINKS TO RELATED DOCUMENTS | | | | | | |
|----------------------------|--------------------------|--|--|--|--|--|
| Dimensions | www.vishay.com/doc?95036 | | | | | |
| Packaging information | www.vishay.com/doc?95037 | | | | | |

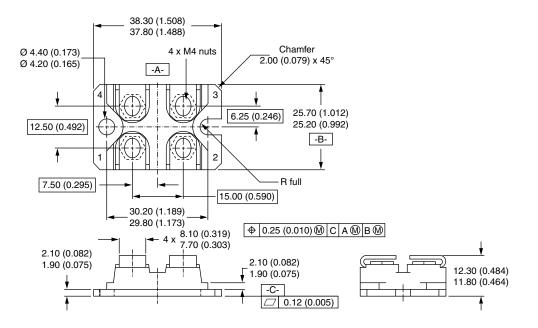


Outline Dimensions

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SOT-227

DIMENSIONS in millimeters (inches)



Notes

- Dimensioning and tolerancing per ANSI Y14.5M-1982
- Controlling dimension: millimeter



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